



## SOT-23 Plastic-Encapsulate MOSFETS

### **CJ2310** N-Channel MOSFET

#### **DESCRIPTION**

The CJ2310 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltage as low as 2.5V. This device is suitable for use as a battery protection or in other switching application.

#### **FEATURES**

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

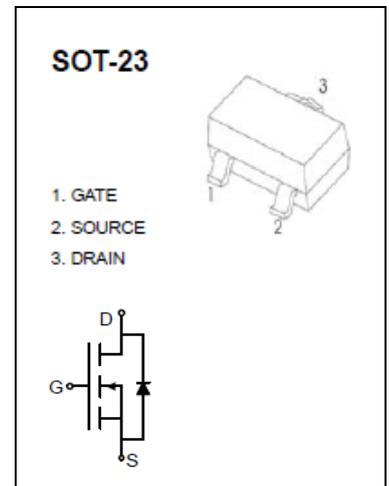
#### **APPLICATION**

- Battery Switch
- DC/DC Converter

#### **MARKING: S10**

#### **Maximum ratings ( $T_a=25^{\circ}\text{C}$ unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	3	A
Pulsed Drain Current (note 1)	$I_{DM}$	10	A
Power Dissipation	$P_D$	0.35	W
Thermal Resistance from Junction to Ambient (note 2)	$R_{\theta JA}$	357	$^{\circ}\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^{\circ}\text{C}$
Storage Temperature	$T_{STG}$	-55~+150	$^{\circ}\text{C}$



**Electrical characteristics (T<sub>a</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	60			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> = 0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> = 0V			±100	nA
Gate threshold voltage (note 3)	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.5		2	V
Drain-source on-resistance (note 3)	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3A			105	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A			125	mΩ
Forward tranconductance (note 3)	g <sub>FS</sub>	V <sub>DS</sub> =15V, I <sub>D</sub> =2A	1.4			S
Diode forward voltage (note 3)	V <sub>SD</sub>	I <sub>S</sub> =3A, V <sub>GS</sub> = 0V			1.2	V
<b>DYNAMIC CHARACTERISTICS (note 4)</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f =1MHz		247		pF
Output Capacitance	C <sub>oss</sub>			34		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			19.5		pF
<b>SWITCHING CHARACTERISTICS (note 4)</b>						
Turn-on delay time	t <sub>d(on)</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =30V, I <sub>D</sub> =1.5A, R <sub>GEN</sub> =1Ω		6		ns
Turn-on rise time	t <sub>r</sub>			15		ns
Turn-off delay time	t <sub>d(off)</sub>			15		ns
Turn-off fall time	t <sub>f</sub>			10		ns
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A		6		nC
Gate-Source Charge	Q <sub>gs</sub>			1		nC
Gate-Drain Charge	Q <sub>gd</sub>			1.3		nC

**Notes :**

1. Repetitive rating : Pulse width limited by junction temperature.
2. Surface mounted on FR4 board , t≤10s.
3. Pulse Test : Pulse Width≤300μs, Duty Cycle≤0.5%.
4. Guaranteed by design, not subject to producing.

# Typical Characteristics

# CJ2310

